

DO NOT REPRODUCE

Loss Tangent	Epsilon R	Color	Thickness (mm)	Material	Type	Layer Name
0	1	Not specified	0 mm	Not specified	Top Silk Screen	F.Silkscreen
0	1	Not specified	0 mm	Not specified	Top Solder Paste	F.Paste
0	3.3	Not specified	0.01 mm	Not specified	Top Solder Mask	F.Mask
0	1	Not specified	0.035 mm	Not specified	copper	F.Cu
0.02	3.95	FR4 natural	0.14 mm	1080	prepreg	Dielectric 1
0	1	Not specified	0.035 mm	Not specified	copper	In1.Cu
0.02	4.6	Not specified	1.1 mm	FR4	core	Dielectric 2
0	1	Not specified	0.035 mm	Not specified	copper	In2.Cu
0.02	3.95	Not specified	0.14 mm	1080	prepreg	Dielectric 3
0	1	Not specified	0.035 mm	Not specified	copper	B.Cu
0	3.3	Not specified	0.01 mm	Not specified	Bottom Solder Mask	B.Mask
0	1	Not specified	0 mm	Not specified	Bottom Solder Paste	B.Paste
0	1	Not specified	0 mm	Not specified	Bottom Silk Screen	B.Silkscreen

BOARD CHARACTERISTICS

1.5820 mm Board Thickness:

4 Copper Layer Count:

0.3000 mm Min hole diameter:

No impedance Control:

No Plated Board Edge:

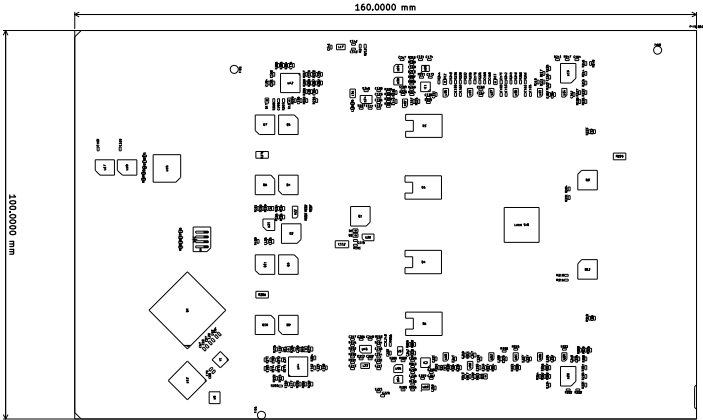
160.0000 mm x 100.0000 mm Board overall dimensions:

0.1200 mm / 0.1300 mm Min track/spacing:

Immersion gold Copper Finish:

No Castellated pads:

No Edge card connectors:



PCB Datasheet



File: cq2.1fcd.pcb		
Sheet:		
Function:	Product: CQ2	Layout Revision: 0.00
Designed by:	Design Date:	Page Revision:
Reviewed by:	Review Date:	
KICad E.D.A. 8.0.4	Issue Date: 2024-07-29	Size: A3 Page: 1/1

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